

Application of

Applicants

: Vishnu K. Agarwal

Serial No.

: 10/633,165

Filed

: August 1, 2003

Title

: SELF-ALIGNED POLY-METAL STRUCTURES

Docket

: MIO 0086 NA/40509.256/00-1137.02

Art Unit

: 2818

Confirm. No.: 4595

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box-1450; Alexandria, VA-22313-1450 on May 31, 2005

Commissioner for Patents

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Sir:

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT <u>UNDER 37 CFR §§ 1.56, 1.97, AND 1.98</u>

Applicant submits herewith patents, publications, and other information of which he is aware, which he believes may be material, as defined in 37 CFR §1.56(b), to the examination of this application and in respect of which there may be a duty to disclose in accordance with 37 CFR §1.56(a). While the information referred to in this Supplemental Information Disclosure Statement may be material pursuant to 37 CFR §1.56(b), the filing of this Supplemental Information Disclosure Statement is not intended to, pursuant to 37 CFR §1.97(h), constitute an admission that any patent, publication, or other information referred to is, or is considered to be, material to the patentability of this invention. No representation is made that a reference is "prior art" within the meaning of 35 U.S.C. §§ 102 and 103, and Applicant reserves the right, pursuant to 37 C.F.R. § 1.131 or otherwise, to establish otherwise. Further, pursuant to 37 CFR §1.97(g), the filing of this Statement should not be construed as a statement that a search has been made or that no other material information exists.

This Supplemental Information Disclosure Statement is being filed after the period set forth in § 1.97(d) and after the mailing date of a final action under § 1/113 or a notice of allowance, but before payment of the issue fee, the Supplemental Information Disclosure

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Statement is accompanied by a check in the amount of \$180.00 in payment of the required fee set forth in 37 CFR § 1.17(p).

This Supplemental Information Disclosure Statement is being filed within the period set forth in 37 CFR §1.97(b) because it is believed that no item of information contained in the supplemental information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information supplemental disclosure statement was known to any individual designated in § 1.56(c) more than three months prior to the filing of the supplemental information disclosure statement.

The Office has waived the requirement pursuant to 37 CFR 1.98 (a)(2)(i) for submitting a copy of each cited U.S. patent and each U.S. patent application publication for all U.S. national patent applications filed after June 30, 2003 and for all international applications that have entered the national stage under 35 USC § 371 after June 30, 2003. Therefore, no copies of each cited U.S. patent and each cited U.S. patent application publication are enclosed, but the cited U.S. patents and the cited U.S. patent application publications are listed on PTO/SB/08A.

Respectfully submitted,
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